

SF-P111

ICT

ICT

ICT PCB

Shengyiifurui Electronic Technology Co., Ltd ISO 9001

2010 PCB ICT SMT IC

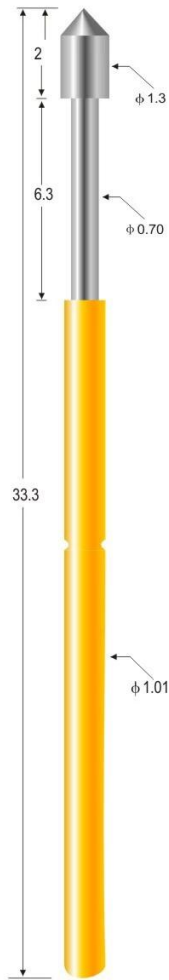


Production Flow (生产流程) **SFENG**
The Choice The Future

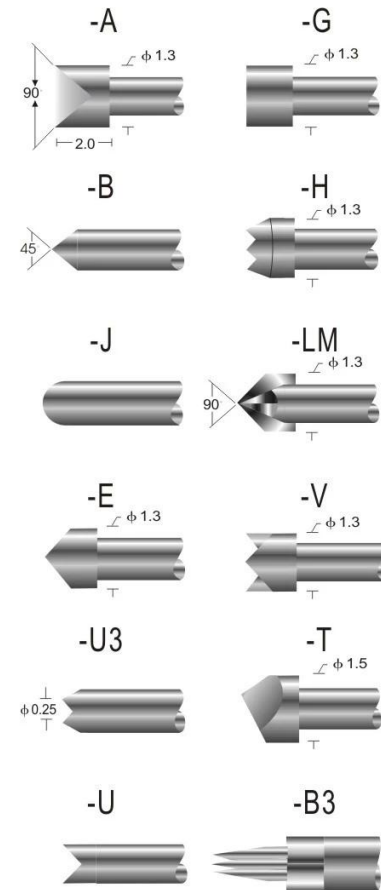
1. raw material warehouse
2. Lathe workshop
3. Assemble workshop
4. Quality inspection
5. Finished products
6. Packing

ICT SF-P111

SF-P111



SF-P111-E



Probe specifications SF-P111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748 ")
- Mounting hole size(钻孔尺寸):
压克力: 1.35mm(.0532 ")
电木板、玻璃纤维板: 1.40mm(.0551 ")
- Full travel(行程): 6.3(.2481 ")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰):
Plunger: Be Cu, Rh plated
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current ration(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)

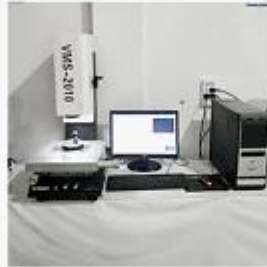
1. PCB ICT FCT

2. pogo

3.

4.

Measuring Equipment >



Measuring Equipment:

1. Agilent current testing;
2. Quadratic element measurement
3. Load Curve Meter
4. Bond Test
5. Life Fatigue Test